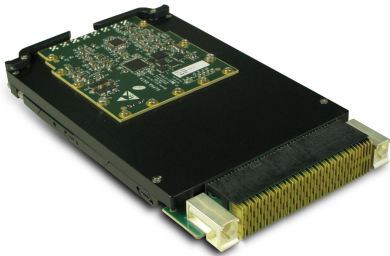


AD01391



## Applications

- Development Platform for AMD Q Grade MPSoCs
- High Altitude Sensor Processing
- Harsh SWaP limited Environments

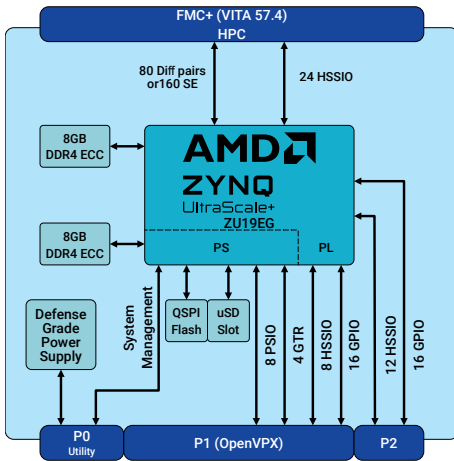
## Board Features

- FMC+ HPC Interface
- Compliant with AMD LVAUX mode for XQ UltraScale+
- Military-Grade Power Supplies from Texas Instruments

## Summary

The **ADM-VPX3-9Z5/DEV** is an OpenVPX MPSoC FPGA System on Module (SoM) utilizing the AMD Zynq UltraScale+ XQZU19EG M-temp device. The ADM-VPX3-9Z5/DEV has been developed in partnership with AMD and Texas Instruments and features Mil-temp range (-55C to +125C) board components throughout for reliability. The ADM-VPX3-9Z5/DEV is suitable for high-altitude applications and is compliant with LVAUX mode for Single Event Effects (SEE). The Open Group Sensor Open Systems Architecture™ influenced the development of this board and the **ADM-VPX3-9Z5** is aligned with the SOSA™ Technical Standard.

The ADM-VPX3-9Z5/DEV provides flexible IO via an FMC+ Site and via the VPX backplane, dual 8GB DDR4-2400 SDRAM (PL and PS), 1Gb QSPI configuration Flash, System Monitoring and Mil-temp enhanced products for Power and Temperature Sensing solutions from Texas Instruments. The ADM-VPX3-9Z5/DEV is compatible with a development Rear Transition Module (p/n ADM-VPX3-9Z5-RTM).



## Target Device

AMD Zynq UltraScale+ MPSoC XQZU19EG-1 (FFRC1760M)

LUTs = 523k FFs = 1045k  
DSPs = 1968  
BRAM = 34.6Mb URAM = 36Mb

4x Arm® Cortex™-A53 MPCore™  
2x Arm Cortex-R5 MPCore  
1x Arm Mali™-400 MP2  
5x PCI Express Gen3 x16 cores  
4x 100G Ethernet MAC/PCS with RS-FEC

## Application Data Memory

1x PS - 1G x 72 (8GiB) DDR4-2400  
1x PL - 1G x 72 (8GiB) DDR4-2400

## Configuration Memory

QSPI 2x 512Mb Flash Memory

## Configuration Modes

Flexible boot options from on-board SPI Flash or uSD Flash

## Deliverables

ADM-VPX3-9Z5/DEV Board  
One Year Warranty  
One Year Technical Support

## Host Interface

Host System Controller Capable  
PCI Express (PS or PL)  
10Gigabit Ethernet

## Board Format

3U VPX (OpenVPX Compliant)

## Input/Output Interfaces

### FMC+ HPC Interface

HSSIO  
Single-Ended/Differential Pair I/O

### OpenVPX Interface

HSSIO (P1)  
HSSIO (P2)

## Environmental Specification

Cooling Option	Operating Temperatures		Storage Temperatures	
	Min	Max	Min	Max
MIL	-55°C	+105°C	-60°C	+150°C

## Operating Humidity

Up to 95% (non-condensing)

## EMC Standards

## Ordering Information

**Order Code: ADM-VPX3-9Z5/DEV/PB**

note

Fitted with AMD Zynq UltraScale+ XQZU19EG-1M, Q Grade FPGA  
MIL temp range.  
Tin/Lead Solder.